AUTOMOTIVE GRADE

International

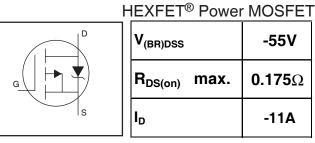
Features

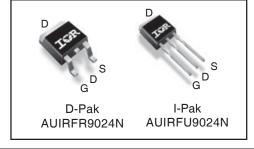
- Advanced Planar Technology
- Low On-Resistance
- P-Channel
- Dynamic dV/dT Rating
- 150°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Repetitive Avalanche Allowed up to Tjmax
- Lead-Free, RoHS Compliant
- Automotive Qualified *

Description

Specifically designed for Automotive applications, this Cellular design of HEXFET® Power MOSFETs utilizes the latest processing techniques to achieve low onresistance per silicon area. This benefit combined with the fast switching speed and ruggedized device design that HEXFET power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in Automotive and a wide variety of other applications.

AUIRFR9024N AUIRFU9024N





G	D	S
Gate	Drain	Source

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ -10V	-11	
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ -10V	-8	A
I _{DM}	Pulsed Drain Current ①	-44	
P _D @T _C = 25°C	Power Dissipation	38	W
	Linear Derating Factor	0.30	W/°C
V _{GS}	Gate-to-Source Voltage	± 20	V
E _{AS}	Single Pulse Avalanche Energy(Thermally limited) 2	62	mJ
I _{AR}	Avalanche Current ①	-6.6	A
E _{AR}	Repetitive Avalanche Energy ①	3.8	mJ
dv/dt	Peak Diode Recovery dv/dt ③	-10	V/ns
TJ	Operating Junction and	-55 to + 150	
T _{STG}	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	

Thermal Resistance

	Parameter	Тур.	Max.	Units
R _{0JC}	Junction-to-Case		3.3	
R _{eJA}	Junction-to-Ambient (PCB mount) **		50	°C/W
R _{0JA}	Junction-to-Ambient		110	

 ${\sf HEXFET}^{\circledast}$ is a registered trademark of International Rectifier. *Qualification standards can be found at http://www.irf.com/

Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	-55			V	$V_{GS} = 0V, I_D = -250\mu A$
$\Delta V_{(BR)DSS} / \Delta T_J$	Breakdown Voltage Temp. Coefficient		-0.05		V/°C	Reference to 25°C, I _D = -1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance			0.175	Ω	V _{GS} = -10V, I _D = -6.6A ④
V _{GS(th)}	Gate Threshold Voltage	-2.0		-4.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
gfs	Forward Transconductance	2.5			S	V _{DS} = -25V, I _D = -7.2A ⑥
I _{DSS}	Drain-to-Source Leakage Current			-25	μA	$V_{DS} = -55V, V_{GS} = 0V$
				-250	I	$V_{DS} = -44V, V_{GS} = 0V, T_{J} = 150^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			100	nA	V _{GS} = -20V
	Gate-to-Source Reverse Leakage			-100		$V_{GS} = 20V$

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Qg	Total Gate Charge	 	19		$I_{\rm D} = -7.2 {\rm A}$
Q _{gs}	Gate-to-Source Charge	 	5.1	nC	$V_{DS} = -44V$
Q _{gd}	Gate-to-Drain ("Miller") Charge	 	10		V _{GS} = -10V,See Fig 6 and 13 ⊕®
t _{d(on)}	Turn-On Delay Time	 13			V _{DD} = -28V
t _r	Rise Time	 55			I _D = -7.2A
t _{d(off)}	Turn-Off Delay Time	 23		ns	$R_{G} = 24 \Omega$
t _f	Fall Time	 37			$R_D = 3.7\Omega$, See Fig.10 \textcircled{G}
L _D	Internal Drain Inductance	 4.5		nH	Between lead, 6mm (0.25in.)
L _S	Internal Source Inductance	 7.5			from package
C _{iss}	Input Capacitance	 350			V _{GS} = 0V
C _{oss}	Output Capacitance	 170		рF	V _{DS} = -25V
C _{rss}	Reverse Transfer Capacitance	 92			f = 1.0MHz,see Fig.5 ©

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions	
I _S	Continuous Source Current			-11		MOSFET symbol	
	(Body Diode)			-11	А	showing the	
I _{SM}	Pulsed Source Current			-44		integral reverse	
	(Body Diode) ①			-44		p-n junction diode.	
V _{SD}	Diode Forward Voltage			-1.6	V	$T_J = 25^{\circ}C, I_S = -7.2A, V_{GS} = 0V$ (4)	
t _{rr}	Reverse Recovery Time		47	71	ns	T _J = 25°C, I _F = -7.2A	
Q _{rr}	Reverse Recovery Charge		84	130	nC	di/dt = 100A/µs ④⑥	
t _{on}	Forward Turn-On Time	Intrinsic	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11).
- (2) Starting $T_J = 25^{\circ}C$, L = 2.8mH
- $R_G = 25\Omega$, $I_{AS} = -6.6A$ (See Figure 12)
- $\label{eq:ISD} \textcircled{3} I_{SD} \leq \textbf{-6.6A}, \ di/dt \leq \textbf{-240A/\mus}, \ V_{DD} \leq V_{(BR)DSS},$

 $T_J \leq 150^\circ C$

(Pulse width \leq 300µs; duty cycle \leq 2%.

- $\ensuremath{\textcircled{\text{S}}}$ This is applied for I-PAK, L_S of D-PAK is measured between lead and center of die contact.
- © Uses IRF9Z24N data and test conditions.

** When mounted on 1" square PCB (FR-4 or G-10 Material). For recommended footprint and soldering techniques refer to application note #AN-994.

Qualification Information[†]

			Automotive				
Qualification Level		(per AEC-Q101) ^{††}					
		qualification.	This part number(s) passed Automotive IR's Industrial and Consumer qualification d by extension of the higher Automotive level.				
Moisture Sensitivity Level		D PAK	MSL1				
WOISture Sensiti		I-PAK	I-PAK N/A				
	Machine Model	Class M2(+/-150V) ^{†††}					
		AEC-Q101-002					
500	Human Body Model	Class H1A(+/-500V) ^{†††}					
ESD	ESD		AEC-Q101-001				
	Charged Device	Class C5(+/-2000V) ^{†††}					
Model		AEC-Q101-005					
RoHS Complian	t	Yes					

t Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

†† Exceptions to AEC-Q101 requirements are noted in the qualification report.

††† Highest passing voltage

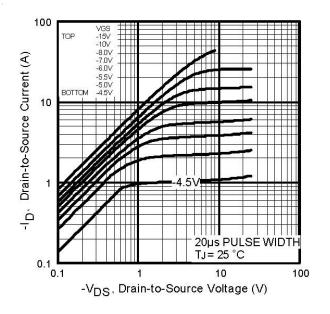


Fig 1. Typical Output Characteristics

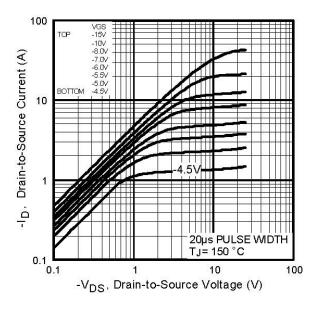


Fig 2. Typical Output Characteristics

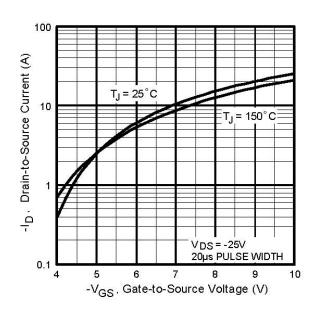


Fig 3. Typical Transfer Characteristics

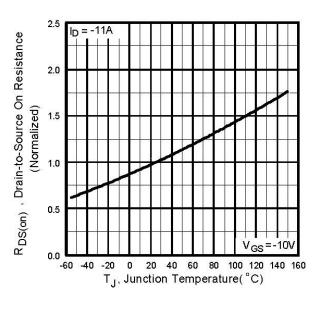
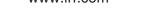


Fig 4. Normalized On-Resistance Vs. Temperature



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International

TOR Rectifier

700

600

500

400

300

200

100

0

C, Capacitance (pF)

 $V_{GS} = 0V$,

Coss = Cds

iss

OSS

rs

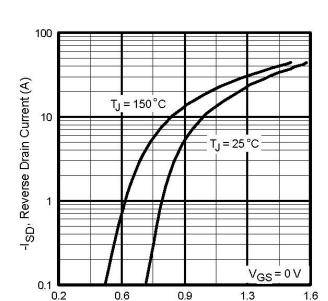
f = 1MHz $C_{iss} = C_{gs} + C_{gd}$, C_{ds} SHORTED $C_{rss} = C_{gd}$

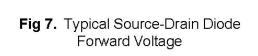
+ Cgd

10

V_{DS} , Drain-to-Source Voltage (V)

Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage



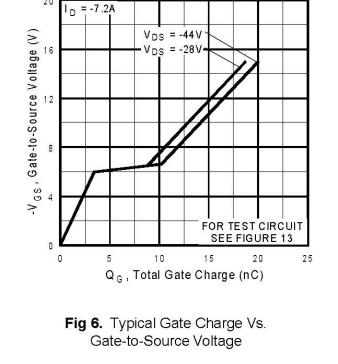


-V_{SD},Source-to-Drain Voltage (V)

1.3

1.6

0.6



20

100

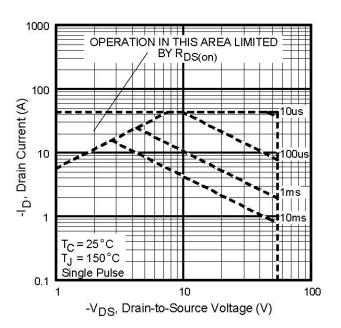
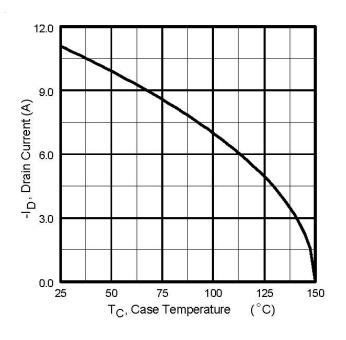
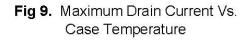
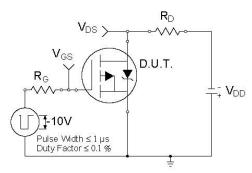


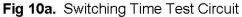
Fig 8. Maximum Safe Operating Area











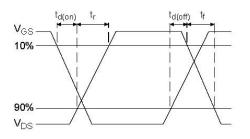


Fig 10b. Switching Time Waveforms

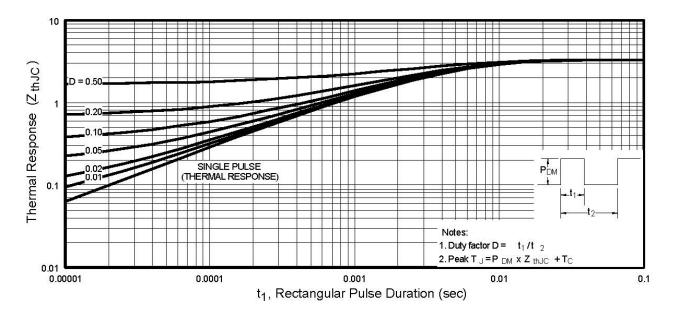


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

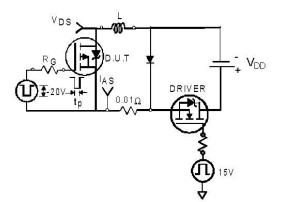


Fig 12a. Unclamped Inductive Test Circuit

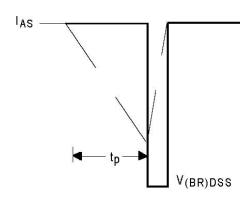


Fig 12b. Unclamped Inductive Waveforms

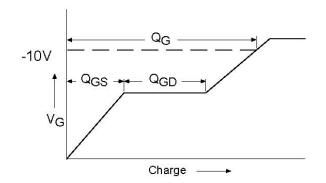
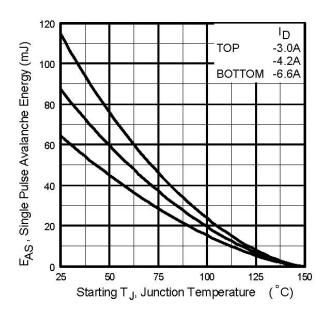
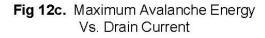


Fig 13a. Basic Gate Charge Waveform





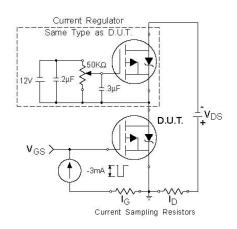
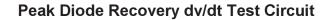
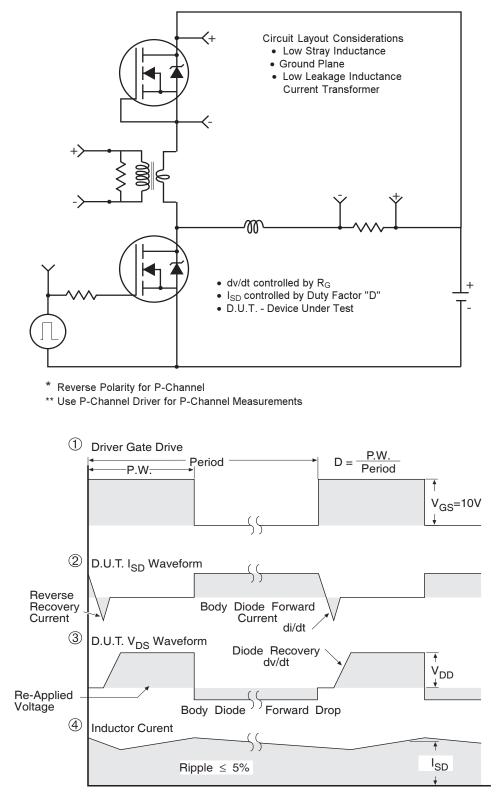


Fig 13b. Gate Charge Test Circuit

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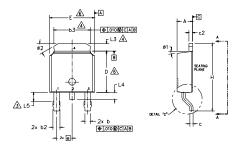


*** V_{GS} = 5.0V for Logic Level and 3V Drive Devices

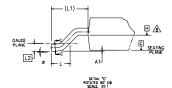


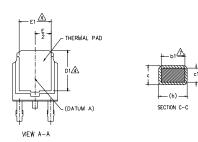
D-Pak (TO-252AA) Package Outline

Dimensions are shown in millimeters (inches)









NΩ	τс	c,	

- 1.- DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
- 2.- DIMENSION ARE SHOWN IN INCHES [MILLIMETERS].
- A- LEAD DIMENSION UNCONTROLLED IN L5.
- A- DIMENSION D1, E1, L3 & 63 ESTABLISH A MINIMUM MOUNTING SURFACE FOR THERMAL PAD. SECTION C-C DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN .005 AND 0.10 [0.13 AND 0.25] FROM THE LEAD TIP. 5,-
- DIMENSION D & E DO NOT INCLUDE MOLD FLASH, MOLD FLASH SHALL NOT EXCEED .005 [0.13] PER 6.-SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
- A- DIMENSION 61 & c1 APPLIED TO BASE METAL ONLY.
- A- DATUM A & B TO BE DETERMINED AT DATUM PLANE H.
- 9.- OUTLINE CONFORMS TO JEDEC OUTLINE TO-252AA

S Y		DIMEN	ISIONS		N	
M B	MILLIM	ETERS	INC	INCHES		
0 L	MIN.	MAX.	MIN.	MAX.	O T E S	
А	2.18	2.39	.086	.094		
A1	-	0.13	-	.005		
ь	0.64	0.89	.025	.035		
ь1	0.65	0.79	.025	.031	7	
b2	0.76	1.14	.030	.045		
bЗ	4.95	5,46	.195	.215	4	
с	0.46	0.61	.018	.024		
c1	0.41	0.56	.016	.022	7	
c2	0.46	0.89	.018	.035		
D	5.97	6.22	.235	.245	6	LEA
D1	5.21	-	.205	-	4	
Е	6,35	6.73	.250	.265	6	HEX
E1	4.32	-	.170	-	4	
е	2,29	BSC	.090	BSC		1
н	9.40	10.41	.370	.410	1	2
L	1.40	1.78	.055	.070		3 4
L1	2.74	BSC	.108	REF.		4
L2	0.51	BSC	.020	BSC		
L3	0.89	1,27	.035	.050	4	IGB
L4	-	1.02	-	.040		100
L5	1.14	1.52	.045	.060	3	1
ø	0*	10*	0*	10*		2
ø1	0*	15*	0*	15*		3
ø2	25'	35*	25'	35*		4
				1		ļ.

AD ASSIGNMENTS

<u>XFET</u>

GATE DRAIN

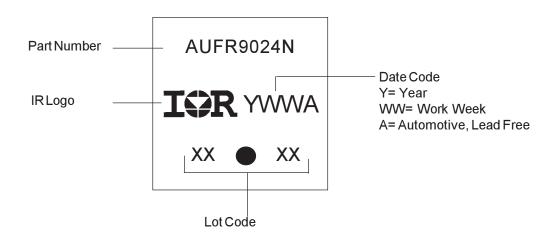
DRAIN

T & CoPAK

GATE COLLECTOR

EMITTER COLLECTOR

D-Pak (TO-252AA) Part Marking Information



I-Pak (TO-251AA) Package Outline (Dimensions are shown in millimeters (inches)

(b, b2)

b1, b3 SECTION A-A

- A ⊕ 0.010 (0.025) (0 C A B -8 С SEATING 11 b2 Зх b Зх Ċ Δ1 ⊕ 0.010 (0.25) ⊕ C A B e \triangle E1

ф

VIEW A-A

NOTES:

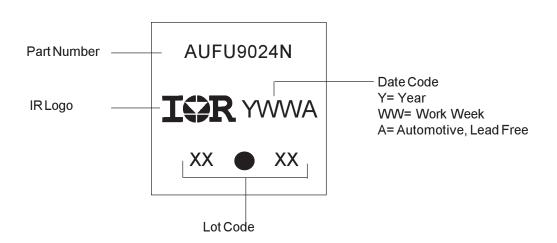
- DIMENSIONING AND TOLERANCING PER ASME Y14.5 M- 1994. 1
- DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES], DMENSION D & E DO NOT INCLUDE WOLD FLASH, MOLD FLASH SHALL NOT EXCEED 0.005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY. 3
- THERMAL PAD CONTOUR OPTION WITHIN DIMENSION 64, L2, E1 & D1.
- LEAD DIMENSION UNCONTROLLED IN L3.
- 6 DIMENSION 61, 63 APPLY TO BASE METAL ONLY.
- OUTLINE CONFORMS TO JEDEC OUTLINE TO-251AA. CONTROLLING DIMENSION : INCHES. 8

LEAD ASSIGNMENTS

DIMENSIONS HEXFET SYMBOL MILLIMETERS INCHES NOTES MIN. MAX. MIN. MAX. 1.- GATE 2.- DRAIN 3.- SOURCE 2.18 0.086 .094 2.39 A1 0,89 1,14 0.035 0,045 4,- DRAIN b 0.64 0.89 0.025 0.035 ь1 0.64 0.025 0.031 4 0,79 b2 0.76 1,14 0.030 0.045 b3 0.76 1.04 0.030 0.041 b4 5.00 5.46 0.195 0.215 4 0.61 0.46 0.018 0.024 с cſ 0.41 0,56 0.016 0.022 c2 .046 0.86 0.018 0.035 D 5.97 6.22 0.235 0.245 3, 4 D1 5.21 0,205 4 6.73 Ε 6.35 0.250 0.265 3, 4 E1 4,32 0,170 4 e 0.09 BSC 9.60 L 8,89 0.350 0,380 L1 1,91 2.29 0.075 0.090 L2 1.27 0.035 0.050 0.89 L3 1,14 1.52 0.045 0,060 5 ø1 0* 15' 0" 15'



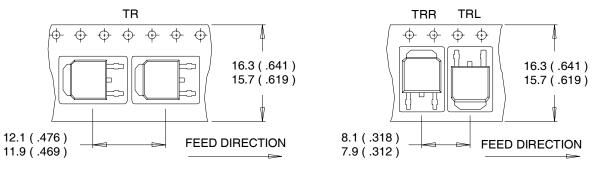
D1 🛆



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

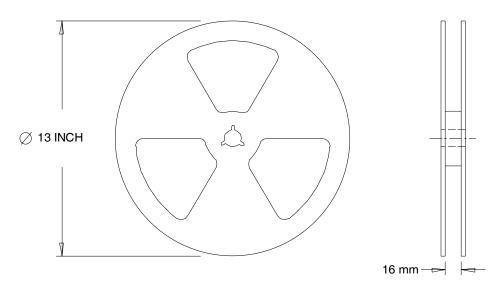
D-Pak (TO-252AA) Tape & Reel Information

Dimensions are shown in millimeters (inches)



NOTES :

- 1. CONTROLLING DIMENSION : MILLIMETER.
- 2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
- 3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES :

1. OUTLINE CONFORMS TO EIA-481.

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Ordering Information

Base part	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRFR9024N	DPak	Tube	75	AUIRFR9024N
		Tape and Reel	2000	AUIRFR9024NTR
		Tape and Reel Left	3000	AUIRFR9024NTRL
		Tape and Reel Right	3000	AUIRFR9024NTRR
AUIRFU9024N	IPak	Tube	75	AUIRFU9024N

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233 Kansas St., El Segundo, California 90245 Tel: (310) 252-7105

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